AP2181/AP2191

1.5A SINGLE CHANNEL CURRENT-LIMITED POWER SWITCH

Features

- Single USB port power switches
- Over-current and thermal protection
- 2.1A accurate current limiting
- Reverse Current Blocking
- 115mΩ on-resistance
- Input voltage range: 2.7V – 5.5V
- 0.6ms typical rise time
- Very low shutdown current: 1uA (max)
- Fault report (FLG) with blanking time (7ms typ)
- ESD protection: 4KV HBM, 400V MM
- Active low (AP2181) or active high (AP2191) enable
- MSOP-8L-EP and DFN2018-6 packages ambient temperature range: -40ºC to 85°C
- SOT25 package ambient temperature range: -20ºC to 70°C
- SOP-8L package ambient temperature range: 0ºC to 70°C
- SOT25, SOP-8L, MSOP-8L-EP (Exposed Pad), and DFN2018-6: Available in "Green" Molding Compound (No Br, Sb)
- Lead Free Finish / RoHS Compliant (Note 1)
- UL Recognized, File Number E322375
- IEC60950-1 CB Scheme Certified
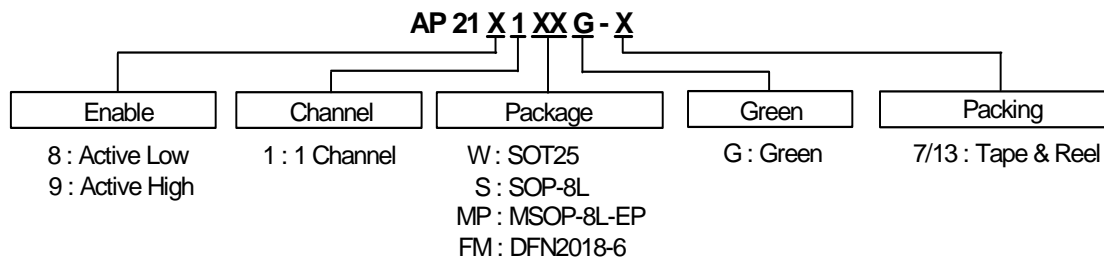
Description

The AP2181 and AP2191 are integrated high-side power switches optimized for Universal Serial Bus (USB) and other hot-swap applications. The family of devices complies with USB 2.0 and available with both polarities of Enable input. They offer current and thermal limiting and short circuit protection as well as controlled rise time and under-voltage lockout functionality. A 7ms deglitch capability on the open-drain Flag output prevents false over-current reporting and does not require any external components.

All devices are available in SOP-8L, MSOP-8L-EP, SOT25, and DFN2018-6 packages.

Applications

- Consumer electronics – LCD TV & Monitor, Game Machines
- Communications – Set-Top-Box, GPS, Smartphone
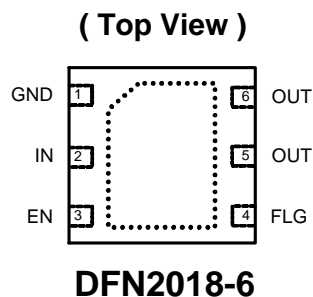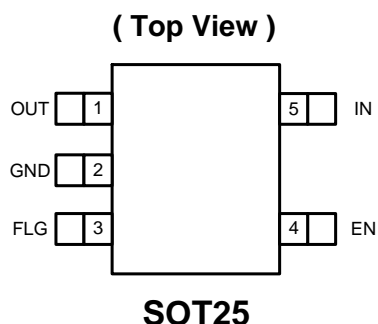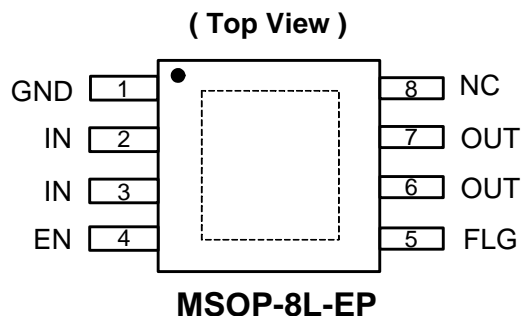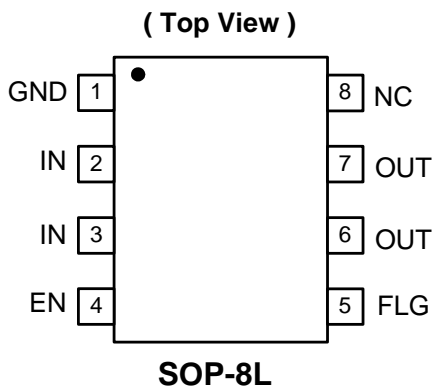- Computing – Laptop, Desktop, Servers, Printers, Docking Station, HUB

Ordering Information

AP 21 **X** 1 **XX** G - **X**

Enable	Channel	Package	Green	Packing
8 : Active Low 9 : Active High	1 : 1 Channel	W : SOT25 S : SOP-8L MP : MSOP-8L-EP FM : DFN2018-6	G : Green	7/13 : Tape & Reel

Device	Package Code	Packaging (Note 2)	7"/13" Tape and Reel	
			Quantity	Part Number Suffix
AP21X1WG-7	W	SOT25	3000/Tape & Reel	-7
AP21X1SG-13	S	SOP-8L	2500/Tape & Reel	-13
AP21X1MPG-13	MP	MSOP-8L-EP	2500/Tape & Reel	-13
AP21X1FMG-7	FM	DFN2018-6	3000/Tape & Reel	-7

Notes: 1. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied. Please visit our website at
http://www.diodes.com/products/lead_free.html.
2. Pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at
http://www.diodes.com/datasheets/ap02001.pdf.

Pin Assignment

(Top View)

GND 1   8 NC
IN 2   7 OUT
IN 3   6 OUT
EN 4   5 FLG

SOP-8L

(Top View)

GND 1   8 NC
IN 2   7 OUT
IN 3   6 OUT
EN 4   5 FLG

MSOP-8L-EP

(Top View)

OUT 1   5 IN
GND 2
FLG 3   4 EN

SOT25

(Top View)

GND 1   6 OUT
IN 2   5 OUT
EN 3   4 FLG

DFN2018-6

Pin Descriptions

| Pin Name	Pin Number			Descriptions
	SOP-8L MSOP-8L-EP	SOT25	DFN2018-6	
GND	1	2	1	Ground
IN	2, 3	5	2	Voltage input pin (all IN pins must be tied together externally)
EN	4	4	3	Enable input, active low (AP2141) or active high (AP2151)
FLG	5	3	4	Over-current and over-temperature fault report; open-drain flag is active low when triggered
OUT	6, 7	1	5, 6	Voltage output pin (all OUT pins must be tied together externally)
NC	8	N/A	N/A	No internal connection; recommend tie to OUT pins

Functional Block Diagram

AP2181, AP2191
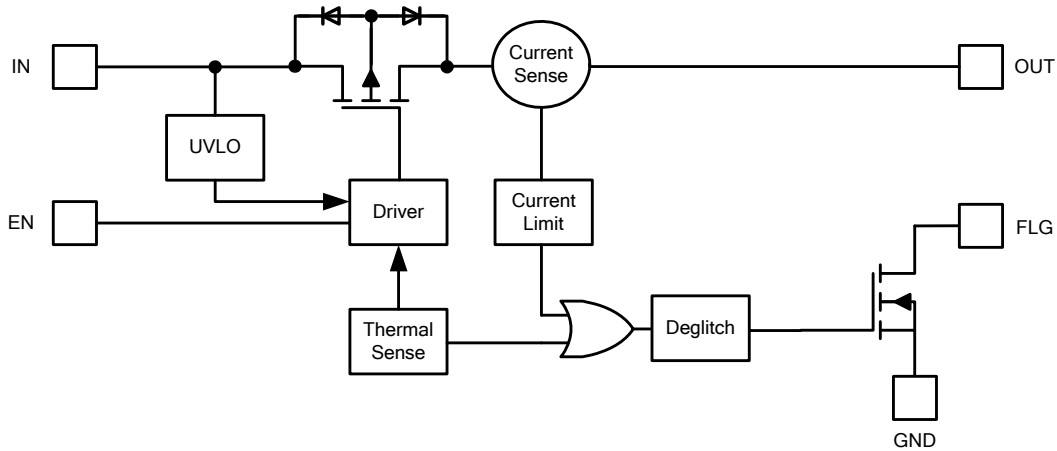
Typical Application Circuit

AP2191 Enable Active High
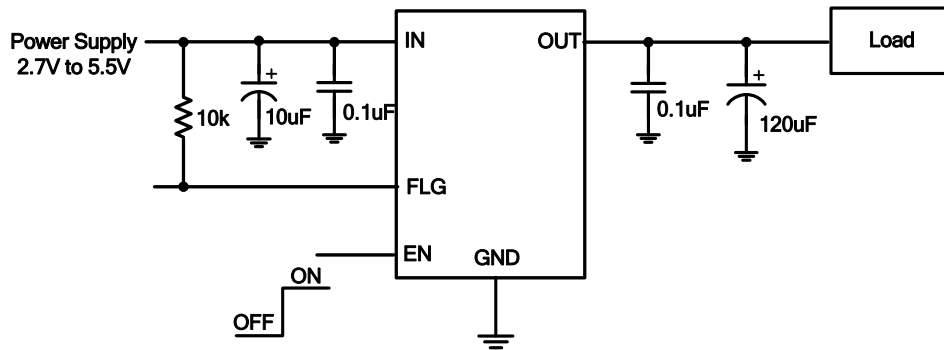
Available Options

Part Number	Channel	Enable pin (EN)	Current limit (typical)	Recommended maximum continuous load current
AP2181	1	Active Low	2.1A	1.5A
AP2191	1	Active High	2.1A	1.5A

Absolute Maximum Ratings

Symbol	Parameter	Ratings	Units
ESD HBM	Human Body Model ESD Protection	4	KV
ESD MM	Machine Model ESD Protection for SOP-8L, MSOP-8L-EP, SOT25 packages	400	V
	Machine Model ESD Protection for DFN2018-6 package	300	V
V_{IN}	Input Voltage	6.5	V
V_{OUT}	Output Voltage	$V_{IN} + 0.3$	V
V_{EN}, V_{FLG}	Enable Voltage	6.5	V
I_{load}	Maximum Continuous Load Current	Internal Limited	A
T_{Jmax}	Maximum Junction Temperature	150	°C
T_{ST}	Storage Temperature Range (Note 3)	-65 to 150	°C

Notes: 3. UL Recognized Rating from -30°C to 70°C (Diodes qualified T_{ST} from -65°C to 150°C)

Recommended Operating Conditions

Symbol	Parameter		Min	Max	Units
V_{IN}	Input voltage		2.7	5.5	V
I_{OUT}	Output Current		0	1.5	A
T_A	Operating Ambient Temperature	MSOP-8L-EP and DFN2018-6	-40	85	°C
		SOT25	-20	70	
		SOP-8L	0	70	

Electrical Characteristics

($T_A = 25^oC$, $V_{IN} = +5.0V$, unless otherwise stated)

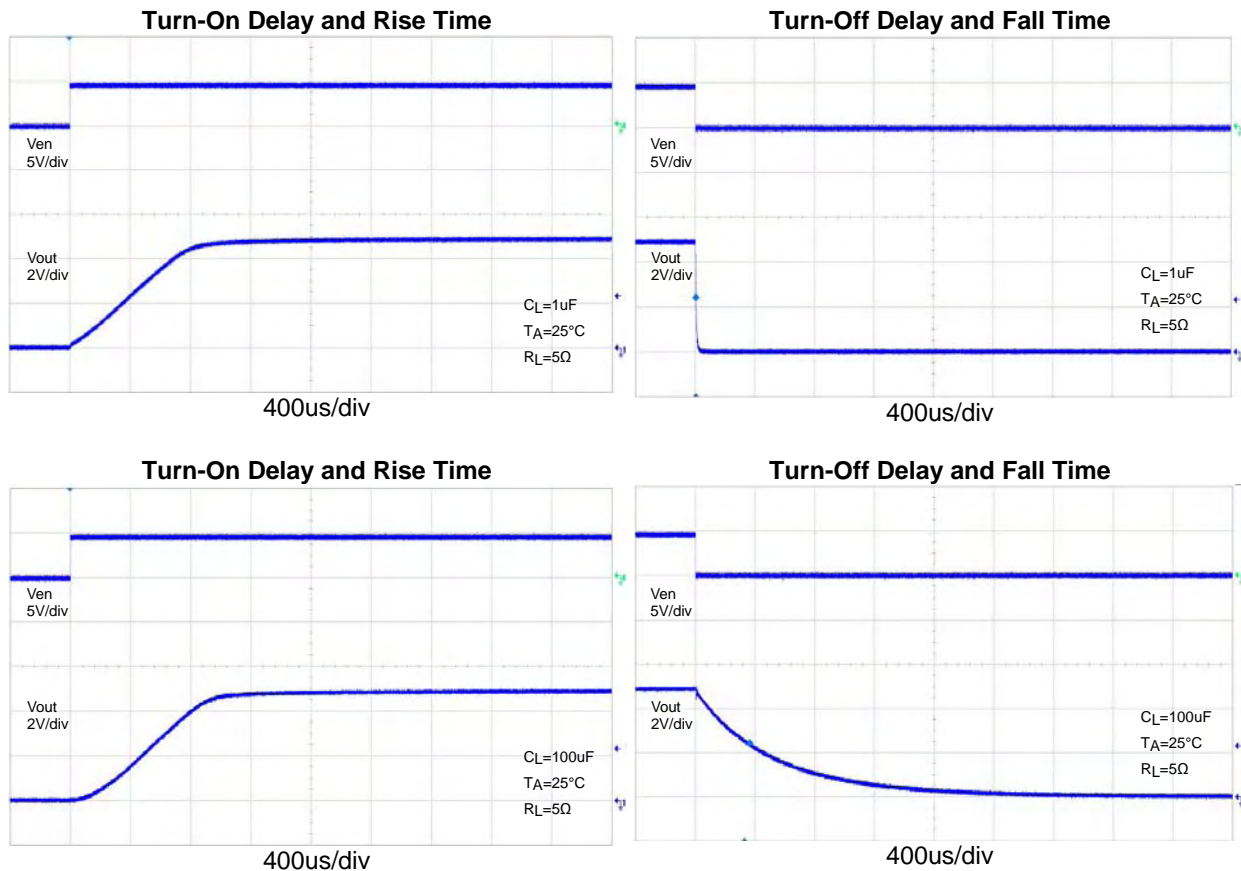| Symbol	Parameter	Test Conditions		Min	Typ.	Max	Unit
V_{UVLO}	Input UVLO	R_{load}=1kΩ		1.6	1.9	2.5	V
I_{SHDN}	Input Shutdown Current	Disabled, I_{OUT}= 0			0.5	1	μA
I_Q	Input Quiescent Current	Enabled, I_{OUT}= 0			45	70	μA
I_{LEAK}	Input Leakage Current	Disabled, OUT grounded				1	μA
I_{REV}	Reverse Leakage Current	Disabled, V_{IN}= 0V, V_{OUT}= 5V, I_{REV} at V_{IN}			1		μA
$R_{DS(ON)}$	Switch on-resistance	V_{IN} = 5V, I_{OUT}= 0.5A	MSOP-8L-EP, -40°C≤ T_A ≤85°C		115	150	mΩ
			SOT25, -20°C ≤ T_A ≤ 70°C		115	150	
			SOP-8L, 0°C ≤ T_A ≤ 70°C		120	160	
			DFN2018-6, -40°C≤ T_A ≤85°C		115	150	
		V_{IN} = 3.3V, I_{OUT}= 0.5A	MSOP-8L-EP & DFN2018-6, -40°C≤ T_A ≤85°C		140	180	mΩ
			SOT25, -20°C ≤ T_A ≤ 70°C & SOP-8L, 0°C ≤ T_A ≤ 70°C				
I_{SHORT}	Short-Circuit Current Limit	Enabled into short circuit, C_L=68μF			2.0		A
I_{LIMIT}	Over-Load Current Limit	V_{IN}= 5V, V_{OUT}= 4.5V, C_L=68μF	MSOP-8L-EP, DFN2018-6, -40°C≤ T_A ≤85°C	1.6	2.1	2.6	A
			SOT25, -20°C ≤ T_A ≤ 70°C & SOP-8L, 0°C ≤ T_A ≤ 70°C				
I_{Trig}	Current limiting trigger threshold	Output Current Slew rate (<100A/s) , C_L=68μF			3.0		A
V_{IL}	EN Input Logic Low Voltage	V_{IN} = 2.7V to 5.5V				0.8	V
V_{IH}	EN Input Logic High Voltage	V_{IN} = 2.7V to 5.5V		2			V
I_{SINK}	EN Input leakage	V_{EN} = 5V				1	μA
$T_{D(ON)}$	Output turn-on delay time	C_L=1μF, R_{load}=10Ω			0.05		ms
T_R	Output turn-on rise time	C_L=1μF, R_{load}=10Ω			0.6	1.5	ms
$T_{D(OFF)}$	Output turn-off delay time	C_L=1μF, R_{load}=10Ω			0.01		ms
T_F	Output turn-off fall time	C_L=1μF, R_{load}=10Ω			0.05	0.1	ms
R_{FLG}	FLG output FET on-resistance	I_{FLG} =10mA, C_L=68μF			30	50	Ω
T_{Blank}	FLG blanking time	C_{IN}=10uF, C_L=68μF		4	7	15	ms
T_{SHDN}	Thermal Shutdown Threshold	Enabled, R_{load}=1kΩ			140		°C
T_{HYS}	Thermal Shutdown Hysteresis				25		°C
θ_{JA}	Thermal Resistance Junction-to-Ambient	SOP-8L (Note 4)			110		^oC/W
		MSOP-8L-EP (Note 5)			60		^oC/W
		SOT25 (Note 6)			157		^oC/W
		DFN2018-6 (Note 7)			70		^oC/W

Notes: 4. Test condition for SOP-8L: Device mounted on FR-4, 2oz copper, with minimum recommended pad layout.
5. Test condition for MSOP-8L-EP: Device mounted on 2" x 2" FR-4 substrate PC board, 2oz copper, with minimum recommended pad on top layer and thermal vias to bottom layer ground plane.
6. Test condition for SOT25: Device mounted on FR-4, 2oz copper, with minimum recommended pad layout.
7. Test condition for DFN2018-6: Device mounted on FR-4 2-layer board, 2oz copper, with minimum recommended pad on top layer and 3 vias to bottom layer 1.0"x1.4" ground plane.
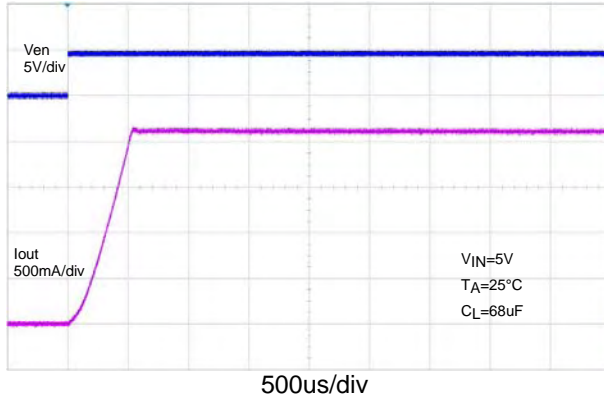
Typical Performance Characteristics

Figure 1. Voltage Waveforms: AP2181 (left), AP2191 (right)
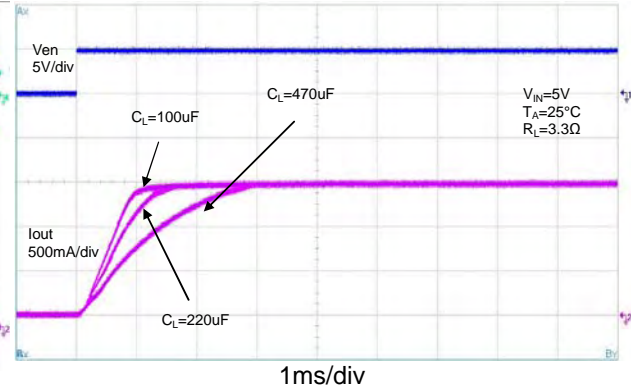
All Enable Plots are for AP2191 Active High

Turn-On Delay and Rise Time

Ven 5V/div

Vout 2V/div

C_L=1uF
T_A=25°C
R_L=5Ω

400us/div

Turn-Off Delay and Fall Time

Ven 5V/div

Vout 2V/div

C_L=1uF
T_A=25°C
R_L=5Ω

400us/div

Turn-On Delay and Rise Time

Ven 5V/div

Vout 2V/div

C_L=100uF
T_A=25°C
R_L=5Ω

400us/div

Turn-Off Delay and Fall Time

Ven 5V/div

Vout 2V/div

C_L=100uF
T_A=25°C
R_L=5Ω

400us/div

Typical Performance Characteristics   (Continued)

**Short Circuit Current,
Device Enabled Into Short**

500us/div

Inrush Current

1ms/div

0.6 Ω Load Connected to Enabled Device

2ms/div
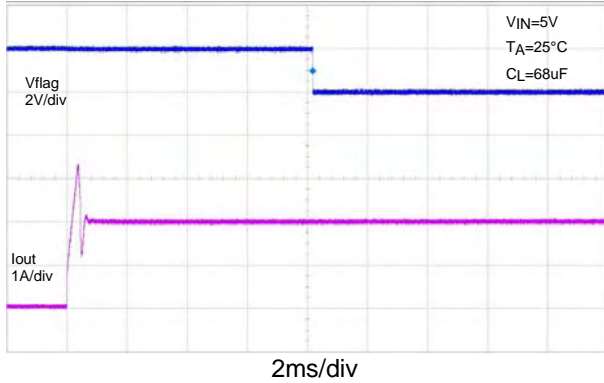
Short Circuit with Blanking Time and Recovery

20ms/div

Power On

1ms/div

UVLO Increasing

1ms/div

AP2181/AP2191

1.5A SINGLE CHANNEL CURRENT-LIMITED POWER SWITCH
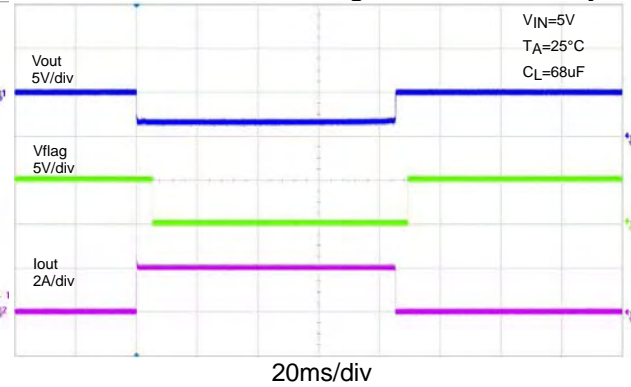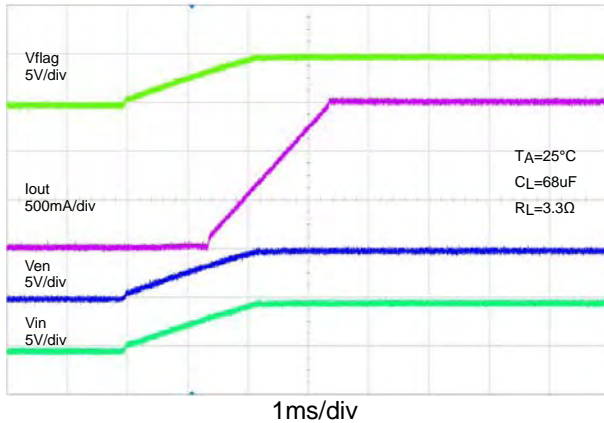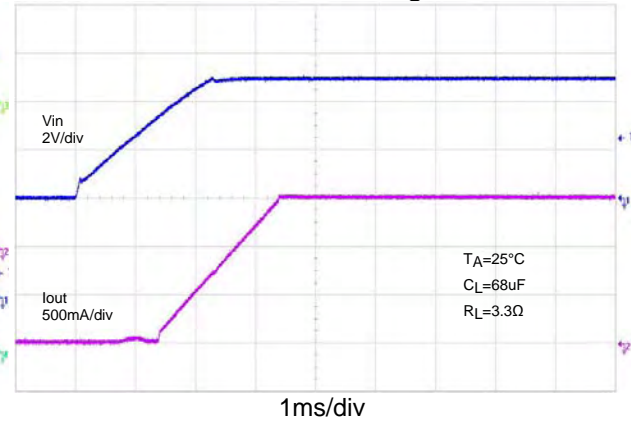
Typical Performance Characteristics   (Continued)

UVLO Decreasing

T_A=25°C
C_L=68uF
R_L=3.3Ω

Vin
2V/div

Iout
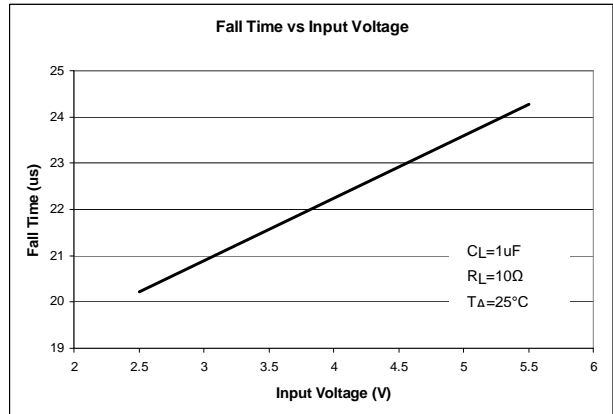500mA/div

10ms/div
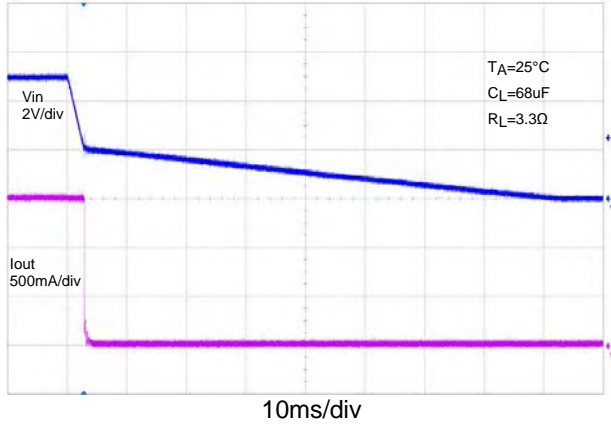
Turn-On Time vs Input Voltage

C_L=1uF
R_L=10Ω
T_A=25°C
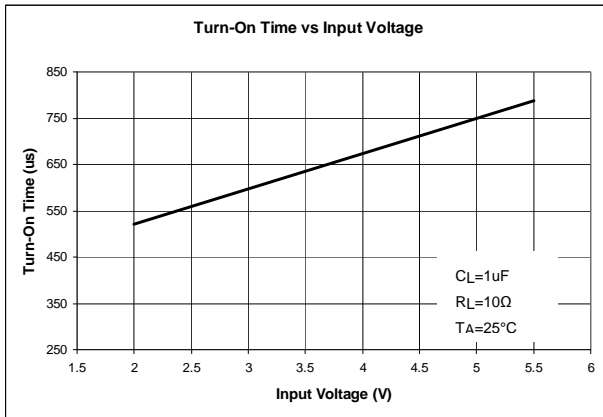
Turn-Off Time vs Input Voltage

C_L=1uF
R_L=10Ω
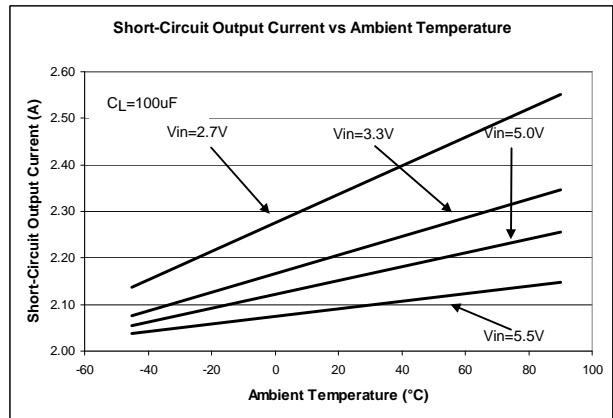T_A=25°C
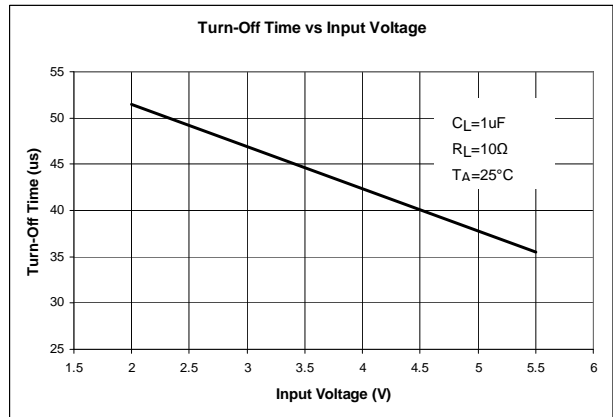
Rise Time vs Input Voltage

C_L=1uF
R_L=10Ω
T_A=25°C

Fall Time vs Input Voltage

C_L=1uF
R_L=10Ω
T_A=25°C

Typical Performance Characteristics   (Continued)

Supply Current, Output Enabled vs Ambient Temperature

Supply Current, Output Disabled vs Ambient Temperature

Static Drain-Source On-State Resistance vs Ambient Temperature

Short-Circuit Output Current vs Ambient Temperature

Undervoltage Lockout vs Ambient Temperature

Threshold Trip Current vs Input Voltage

Typical Performance Characteristics (Continued)

Current Limit Response vs Peak Current

Chart: X-axis labeled "Peak Current (A)" ranging from 0 to 12. Y-axis labeled "Current Limit Response (us)" ranging from 0 to 45.

$V_{IN}=5V$

$T_A=25°C$
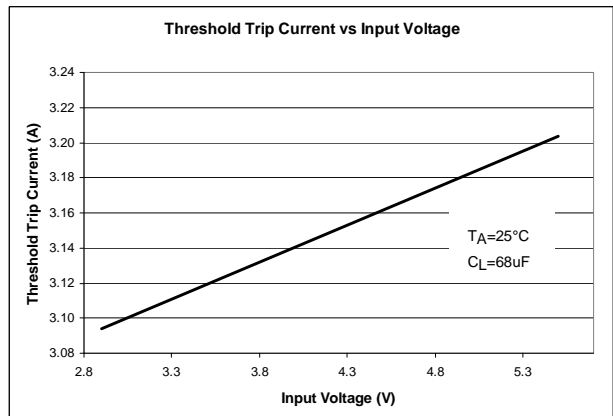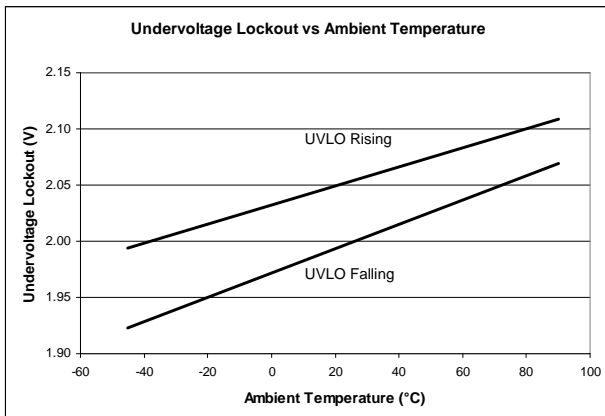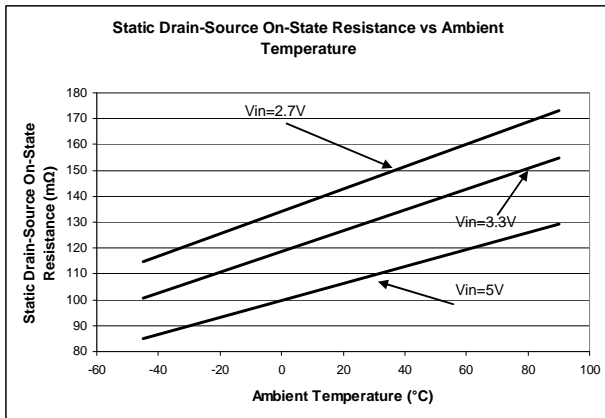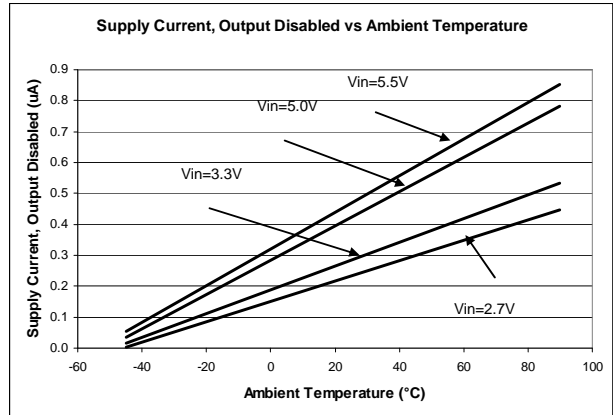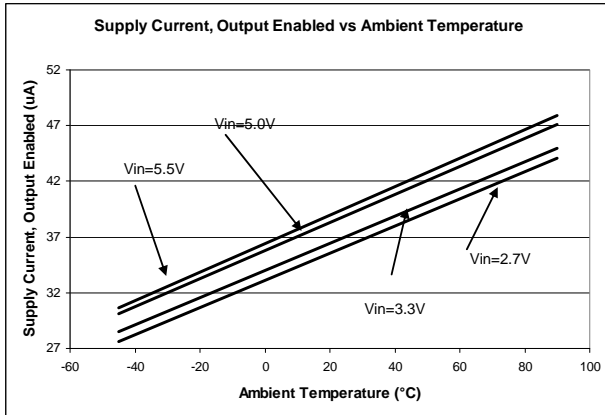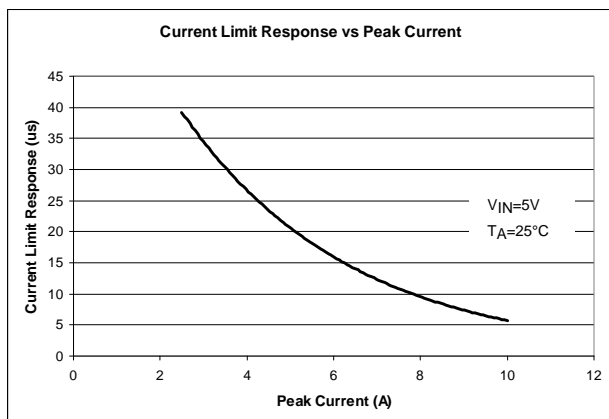
Application Note

Power Supply Considerations

A 0.01-µF to 0.1-µF X7R or X5R ceramic bypass capacitor between IN and GND, close to the device, is recommended. Placing a high-value electrolytic capacitor on the input and output pin(s) is recommended when the output load is heavy. This precaution reduces power-supply transients that may cause ringing on the input. Additionally, bypassing the output with a 0.01-µF to 0.1-µF ceramic capacitor improves the immunity of the device to short-circuit transients.

Over-current and Short Circuit Protection

An internal sensing FET is employed to check for over-current conditions. Unlike current-sense resistors, sense FETs do not increase the series resistance of the current path. When an overcurrent condition is detected, the device maintains a constant output current and reduces the output voltage accordingly. Complete shutdown occurs only if the fault stays long enough to activate thermal limiting.

Three possible overload conditions can occur. In the first condition, the output has been shorted to GND before the device is enabled or before V_{IN} has been applied. The AP2181/AP2191 senses the short circuit and immediately clamps output current to a certain safe level namely I_{LIMIT}.

In the second condition, an output short or an overload occurs while the device is enabled. At the instance the overload occurs, higher current may flow for a very short period of time before the current limit function can react. After the current limit function has tripped (reached the over-current trip threshold), the device switches into current limiting mode and the current is clamped at I_{LIMIT}.

In the third condition, the load has been gradually increased beyond the recommended operating current. The current is permitted to rise until the current-limit threshold (I_{TRIG}) is reached or until the thermal limit of the device is exceeded. The AP2181/AP2191 is capable of delivering current up to the current-limit threshold without damaging the device. Once the threshold has been reached, the device switches into its current limiting mode and is set at I_{LIMIT}.

FLG Response

When an over-current or over-temperature shutdown condition is encountered, the FLG open-drain output goes active low after a nominal 7-ms deglitch timeout. The FLG output remains low until both over-current and over-temperature conditions are removed. Connecting a heavy capacitive load to the output of the device can cause a momentary over-current condition, which does not trigger the FLG due to the 7-ms deglitch timeout. The AP2181/AP2191 is designed to eliminate false over-current reporting without the need of external components to remove unwanted pulses.

Power Dissipation and Junction Temperature

The low on-resistance of the internal MOSFET allows the small surface-mount packages to pass large current. Using the maximum operating ambient temperature (T_A) and $R_{DS(ON)}$, the power dissipation can be calculated by:

$$P_D = R_{DS(ON)} \times I^2$$

Finally, calculate the junction temperature:

$$T_J = P_D \times R_{\theta JA} + T_A$$

Where:

T_A = Ambient temperature °C
$R_{\theta JA}$ = Thermal resistance
P_D = Total power dissipation

Application Note (Continued)

Thermal Protection

Thermal protection prevents the IC from damage when heavy-overload or short-circuit faults are present for extended periods of time. The AP2181/AP2191 implements a thermal sensing to monitor the operating junction temperature of the power distribution switch. Once the die temperature rises to approximately 140°C due to excessive power dissipation in an over-current or short-circuit condition the internal thermal sense circuitry turns the power switch off, thus preventing the power switch from damage. Hysteresis is built into the thermal sense circuit allowing the device to cool down approximately 25°C before the switch turns back on. The switch continues to cycle in this manner until the load fault or input power is removed. The FLG open-drain output is asserted when an over-temperature shutdown or over-current occurs with 7-ms deglitch.

Under-voltage Lockout (UVLO)

Under-voltage lockout function (UVLO) keeps the internal power switch from being turned on until the power supply has reached at least 1.9V, even if the switch is enabled. Whenever the input voltage falls below approximately 1.9V, the power switch is quickly turned off. This facilitates the design of hot-insertion systems where it is not possible to turn off the power switch before input power is removed.

Host/Self-Powered HUBs

Hosts and self-powered hubs (SPH) have a local power supply that powers the embedded functions and the downstream ports (see Figure 2). This power supply must provide from 5.25V to 4.75V to the board side of the downstream connection under both full-load and no-load conditions. Hosts and SPHs are required to have current-limit protection and must report over-current conditions to the USB controller. Typical SPHs are desktop PCs, monitors, printers, and stand-alone hubs.
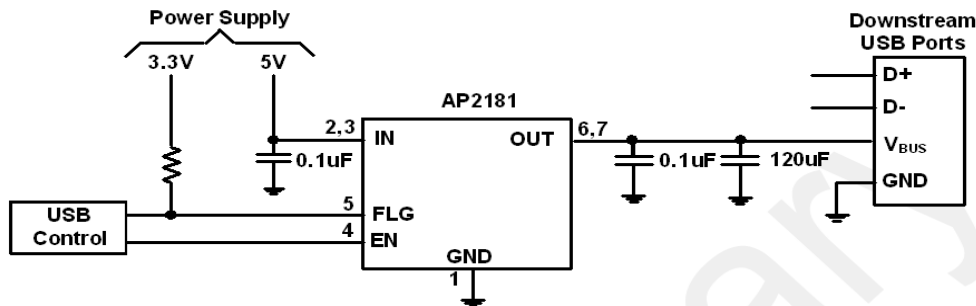

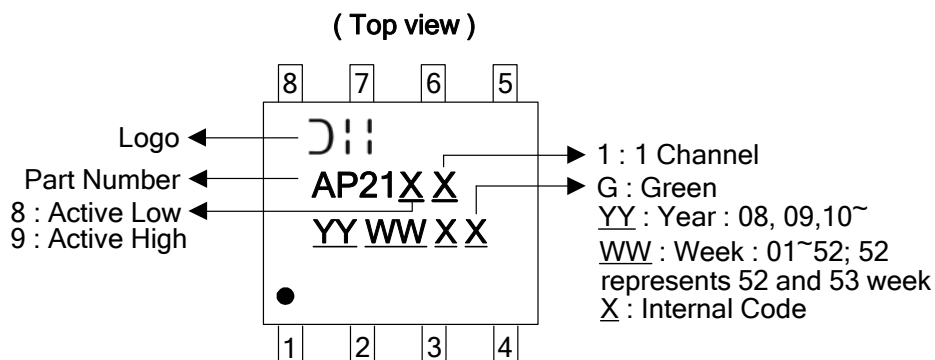**Figure 2. Typical One-Port USB Host / Self-Powered Hub**

Generic Hot-Plug Applications

In many applications it may be necessary to remove modules or pc boards while the main unit is still operating. These are considered hot-plug applications. Such implementations require the control of current surges seen by the main power supply and the card being inserted. The most effective way to control these surges is to limit and slowly ramp the current and voltage being applied to the card, similar to the way in which a power supply normally turns on. Due to the controlled rise times and fall times of the AP2181/AP2191, these devices can be used to provide a softer start-up to devices being hot-plugged into a powered system. The UVLO feature of the AP2181/AP2191 also ensures that the switch is off after the card has been removed, and that the switch is off during the next insertion.
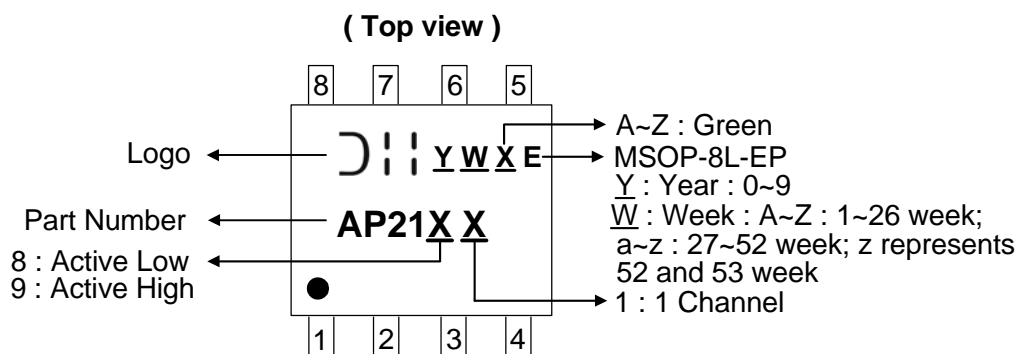
By placing the AP2181/AP2191 between the Vcc input and the rest of the circuitry, the input power reaches these devices first after insertion. The typical rise time of the switch is approximately 1ms, providing a slow voltage ramp at the output of the device. This implementation controls system surge current and provides a hot-plugging mechanism for any device.
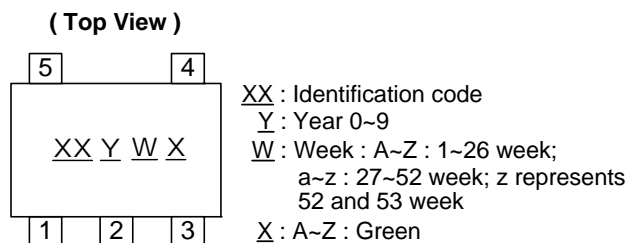
Marking Information

(1) SOP-8L

(Top view)

Logo ◄

Part Number ◄

8 : Active Low ◄
9 : Active High

AP21X X

YY WW X X

► 1 : 1 Channel
► G : Green
YY : Year : 08, 09,10~
WW : Week : 01~52; 52 represents 52 and 53 week
X : Internal Code

(2) MSOP-8L-EP

(Top view)

Logo ◄

Part Number ◄

8 : Active Low ◄
9 : Active High

Y W X E

AP21X X

► A~Z : Green
► MSOP-8L-EP
Y : Year : 0~9
W : Week : A~Z : 1~26 week;
a~z : 27~52 week; z represents 52 and 53 week
► 1 : 1 Channel

(3) SOT25

(Top View)

XX Y W X

XX : Identification code
Y : Year 0~9
W : Week : A~Z : 1~26 week;
a~z : 27~52 week; z represents 52 and 53 week
X : A~Z : Green

Device	Package type	Identification Code
AP2181W	SOT25	HX
AP2191W	SOT25	HY

Marking Information   (Continued)

(4) DFN2018-6

(Top View)
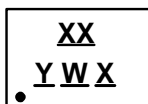
XX
Y W X
●

XX : Identification Code
Y : Year : 0~9
W : Week : A~Z : 1~26 week;
    a~z : 27~52 week; z represents
    52 and 53 week
X : A~Z : Green

Device	Package type	Identification Code
AP2181FM	DFN2018-6	HX
AP2191FM	DFN2018-6	HY

Package Information   (All Dimensions in mm)

(1) Package Type: SOP-8L

3.85/3.95
5.90/6.10
0.10/0.20
0.254
Gauge Plane
Seating Plane
0.62/0.82
Detail "A"

7°~9°
1.30/1.50
1.75max
0.15/0.25
0.35max
45°
7°~9°
Detail "A"
0°/8°
1.27typ
0.3/0.5
4.85/4.95

8x-0.60
5.4
6x-1.27
8x-1.55
Land Pattern Recommendation
(Unit: mm)
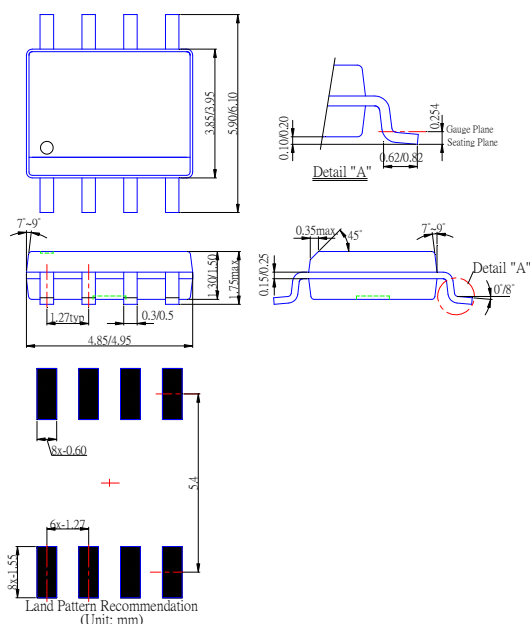
Package Information   (Continued)

(2) Package Type: MSOP-8L-EP

(3) Package Type: SOT25

AP2181/AP2191

1.5A SINGLE CHANNEL CURRENT-LIMITED POWER SWITCH
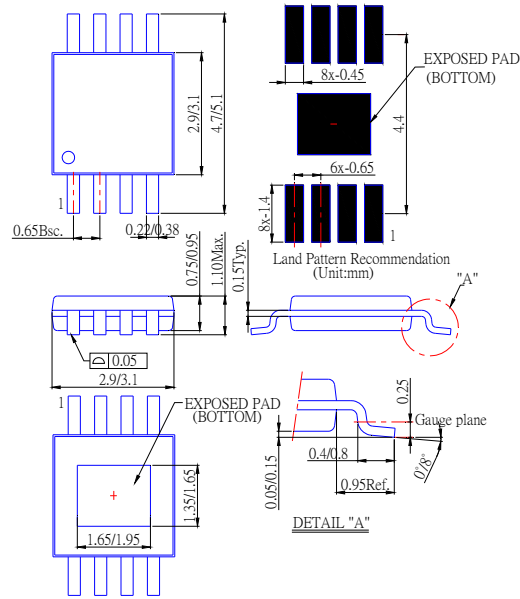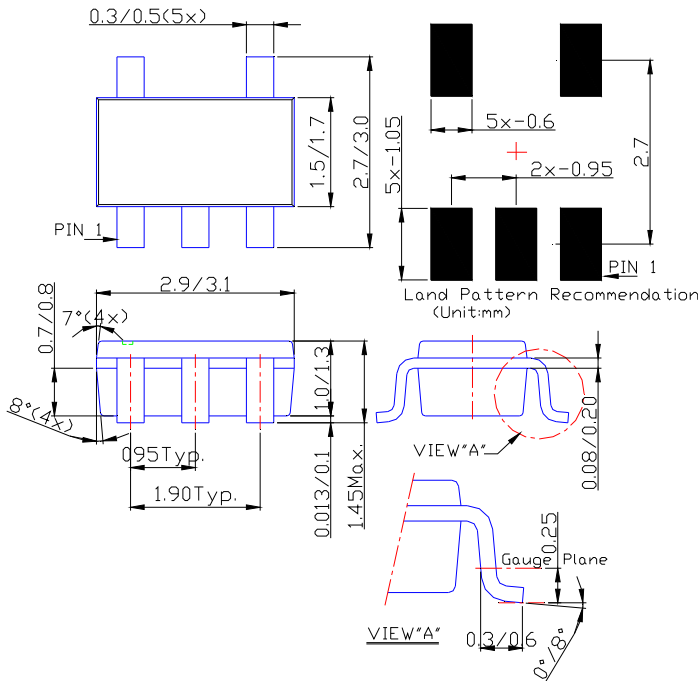
Package Information (Continued)

(4) Package Type: DFN2018-6

Side View

Seating Plane

Bottom View
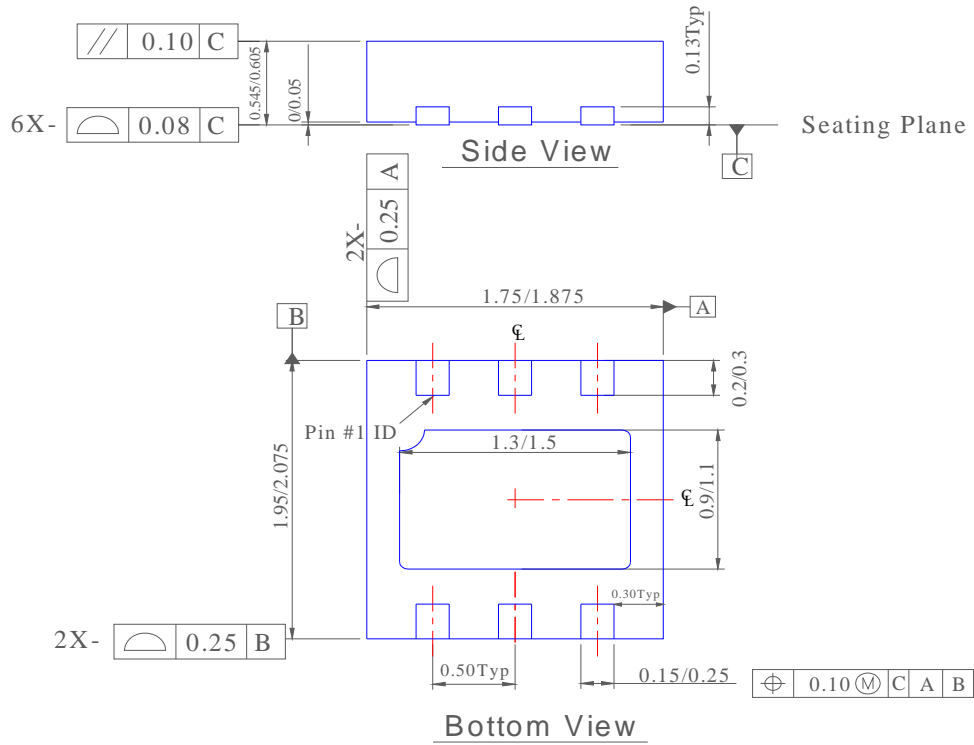
Taping Orientation
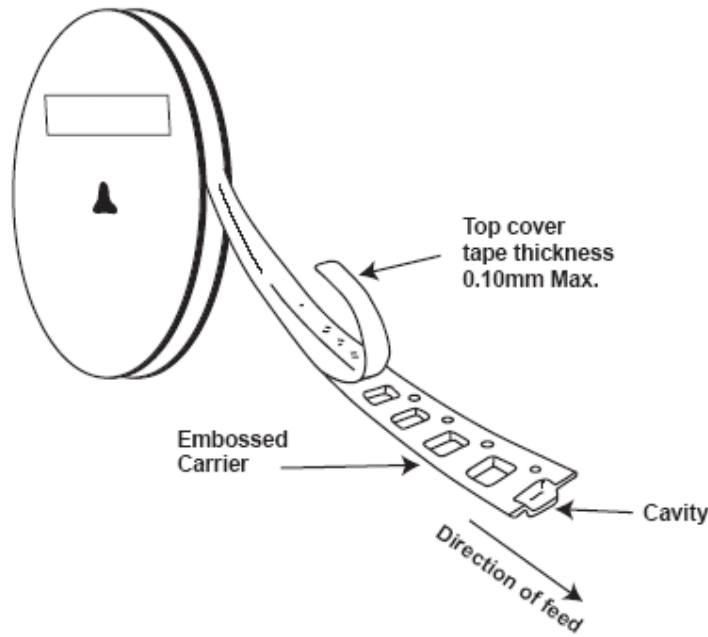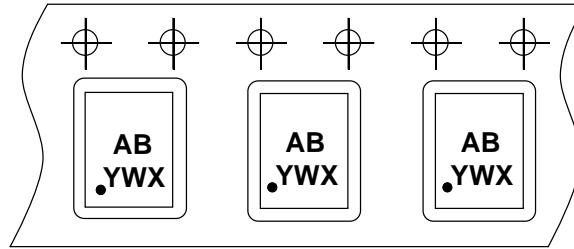
Notes: 8. The taping orientation of the other package type can be found on our website at http://www.diodes.com/datasheets/ap02007.pdf